EVERLIGHT EVERLIGHT ELECTRONICS CO., LTD.

Technical Data Sheet

Chip LED with Right Angle Lens

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow

solder process.

- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

Descriptions

- The 12-21 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: Indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

Part No.	Chip Material	Emitted Color	Resin Color
12-21/GHC-YR2S2/2C	InGaN	Brilliant Green	Water Clear



12-21/GHC-YR2S2/2C



Package Outline Dimensions









Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

http://www.everlight.com Prepared date: 05-Mar-2008 EVERLIGHT EVERLIGHT ELECTRONICS CO., LTD.

12-21/GHC-YR2S2/2C

Absolute Maximum Ratings (Ta=25°C)					
Parameter	Symbol	Rating	Unit		
Reverse Voltage	V _R	5	V		
Forward Current	I _F	25	mA		
Peak Forward Current		100			
(Duty 1/10 @1KHz)	I _{FP}	100	mA		
Power Dissipation	P _d	95	mW		
Electrostatic Discharge (HBM)	ESD	150	V		
Operating Temperature	Topr	-40 ~ +85	°C		
Storage Temperature	Tstg	-40 ~ +90	°C		
		Reflow Soldering :260 °C for 10 sec.			
Soldering Temperature	Tsol	Hand Soldering : 350 $^{\circ}$ C for 3 sec.			

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	I _V	140		285	mcd	
Viewing Angle	201/2		120		deg	
Peak Wavelength	λp		518		nm	
Dominant Wavelength	λd	520		535	nm	I _F =20mA
Spectrum Radiation Bandwidth	$ riangle \lambda$		35		nm	
Forward Voltage	V_{F}	2.7	3.3	3.7	V	
Reverse Current	I _R			50	μΑ	V _R =5V

Notes:

1.Tolerance of Luminous Intensity: ±11%2.Tolerance of Dominant Wavelength: ±1nm

Bin Range Of Dom. Wavelength

EVERLIGHT

Group	Bin	Min	Max	Unit	Condition	
	Х	520	525	nm		
Y	Y	525	530		I _F =20mA	
	Z	530	535			

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition
R2	140	180		
S1	180	225	mcd	I _F =20mA
S2	225	285		

Notes:

1.Tolerance of Luminous Intensity ±11%

2.Tolerance of Dominant Wavelength ±1nm

Typical Electro-Optical Characteristics Curves

EVERLIGHT



Label explanation

CAT: Luminous Intensity Rank

- HUE: Dom. Wavelength Rank
 - **REF: Forward Voltage Rank**



Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

http://www.everlight.com Prepared date: 05-Mar-2008

12-21/GHC-YR2S2/2C

Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below. Confidence level : 90% LTPD : 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100°C 15min ∫ 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H : +100°C 5min ∫ 10 sec L : -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/85%RH	1000 Hrs.	22 PCS.	0/1

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package, the LEDs should be kept at 30° C or less and 90%RH or less.
 - 2.3 After opening the package: The LED's floor life is 1 year under 30℃ or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
 - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
 - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD. Office: No 25, Lane 76, Sec 3, Chung Yang Rd,

Tucheng, Taipei 236, Taiwan, R.O.C

Tel: 886-2-2267-2000, 2267-9936 *Fax:* 886-2267-6244, 2267-6189, 2267-6306 *http://www.everlight.com*

Everlight Electronics Co., Ltd. Device No. : SZDSE-121-G05 http://www.everlight.com Prepared date: 05-Mar-2008 Rev.2 Page: 10 of10 Prepared by:LeiHui